

Title (en)

DEVICE FOR CONTACTING A PRINTED CIRCUIT

Title (de)

VORRICHTUNG ZUR KONTAKTIERUNG EINER LEITERPLATTE

Title (fr)

DISPOSITIF POUR CONTACTER UN CIRCUIT IMPRIMÉ

Publication

**EP 2815462 B1 20180808 (DE)**

Application

**EP 13702340 A 20130124**

Priority

- DE 202012001645 U 20120217
- EP 2013000214 W 20130124

Abstract (en)

[origin: CA2876631A1] The invention relates to a device for contacting a circuit board (18), comprising one or more contact elements (14), an intake into which at least one section of the circuit board (18) can be inserted, means for moving the circuit board (18) relative to the contact elements (14) until the contact elements (14) are contacted, and means for fixing the circuit board in the position in which the contact elements (14) are contacted.

IPC 8 full level

**H01R 12/81** (2011.01); **H01R 11/24** (2006.01); **H01R 12/77** (2011.01)

CPC (source: EP US)

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Citation (examination)

EP 0131410 A2 19850116 - TOKYO TATSUNO KK [JP]

Designated contracting state (EPC)

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